

1.6 x 1.25 mm High Temperature Series

Features

- Ideal for indication light on hand held products
- Long life and robust package
- Standard Package: 2,000pcs/ Reel
- MSL (Moisture Sensitivity Level): 3
- Halogen-free
- RoHS compliant





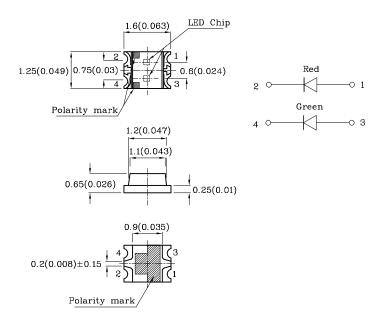


ATTENTION
OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES

Applications

- Backlighting for tell-tale indicators
- Dashboard lighting
- Interior lighting (footwell, dome light, accent lighting, etc.)
- Exterior lighting (turn signals, side markers, CHMSL, etc.)
- Signs and signals
- Various applications requiring high temperature rating

Package Schematics



Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is \pm 0.2(0.008") unless otherwise noted.
- 3. Specifications are subject to change without notice.

Dec 11,2020



Part Number: XZMDKVG62W5MAV-1HTA

$1.6 \times 1.25 \text{ mm}$ High Temperature Series

Part Number	Emitting Color	Emitting Material	$\begin{array}{c} \text{Luminous Intensity} \\ \text{CIE}127\text{-}2007* \\ \text{(I$_{\text{F}}$=}5\text{mA}) \\ \text{mcd} \end{array}$			Lens-color	Viewing Angle 20 1/2
			Code.	min.	max.		
			U	50	80		
	Red	AlGaInP V 80 120					
-XZMDKVG62W5MAV-1HTA	Rea	AlGainP	R*	15*	20*		
			S*	20*	30*	-	
			P	6	10	W Cl	1 700
			Q	10	15	- Water Clear	150°
	C.	AICL I D	R	15	20		
	Green	AlGaInP	P*	6*	10*	- - -	
			Q*	10*	15*		
			R*	15*	20*		

Note:

Absolute Maximum Ratings at Ta=25°C

D	G 1 1	Va	** **		
Parameter	Symbol	Red	Green	Unit	
Power dissipation	P_{D}	75	75	mW	
Reverse Voltage	V_{R}	5	5	v	
Junction temperature	TJ	115	115	°C	
Operating Temperature	Тор	-40 To	°C		
Storage Temperature	Tstg	-40 To	°C		
DC Forward Current	IF	30	30	mA	
Peak Forward Current [2]	IFM	185	150	mA	
Electrostatic Discharge Threshold (HBM)		3000	3000	V	
Thermal Resistance (Junction/ambient) [1]	Rth j-a	650	780	°C/W	
Thermal Resistance (Junction / Solder point) [1]	Rth j-s	500	620	°C/W	

Notes

- 1. Rth(j-a) Results from mounting on PC board FR4 (pad size≥16 mm² per pad),
- 2. 1/10 Duty Cycle, 0.1ms Pulse Width.
- 3. A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033)

Dec 11,2020 XDSB9286 V3-X Layout: Maggie L.

^{1.01/2} is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

^{*}Luminous intensity value is in accordance with CIE127-2007 standards.



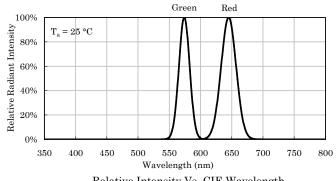


Electrical / Optical Characteristics at Ta=25°C

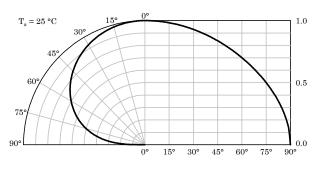
D	G 1 1	Chin		Va	TT *4		
Parameter	Symbol	Chip	Code.	Min.	Typ.	Max.	Unit
Wavelength at peak emission CIE127-2007* IF = $5mA$	λpeak	Red Green	-	-	645* 574*		nm
		Red	-	620*	-	640*	
D : , W 1 (1019195 9005* In 5 A	N 1 (11)	λdom [1] 4* 565* Green 5* 567*	-	567*			
Dominant Wavelength CIE127-2007* IF = 5mA	Adom [1]		5*	567*	-	569*	nm
			6*	569*	-	571*	
Spectral bandwidth at $50\%\Phi$ REL MAX IF = $5mA$	Δλ	Red Green	-	-	28 20	-	nm
Forward Voltage IF = 5mA	VF [2]	Red Green	-	-	1.8 1.95	2.3 2.4	V
Reverse Current (VR = 5V)	IR	Red Green	-	-	-	10 10	μΑ
Temperature coefficient of λ peak IF = 5mA, -10° C \leq T \leq 100°C	TCλpeak	Red Green	-	-	0.14 0.12	-	nm/°C
Temperature coefficient of λ dom IF = 5mA, -10°C \leq T \leq 100°C	TCλdom	Red Green	-	-	0.05 0.08	-	nm/°C
Temperature coefficient of VF $IF = 5mA, -10^{\circ}C \le T \le 100^{\circ}C$	TCv	Red Green	-	-	-1.9 -1.9	-	mV/°C

Notes:

- 1. Wavelength: +/-1nm.
- 2. Forward Voltage: +/-0.1V.
- $\mbox{*}$ Wavelength value is in accordance with CIE127-2007 standards.



Relative Intensity Vs. CIE Wavelength



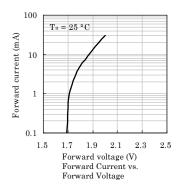
Spatial Distribution

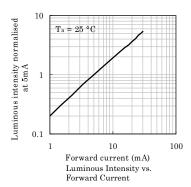
XDSB9286 V3-X Layout: Maggie L.

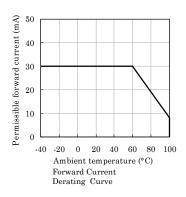


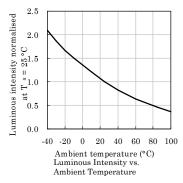


Red

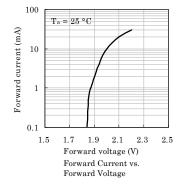


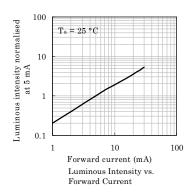


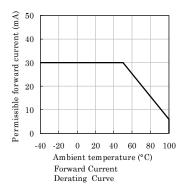


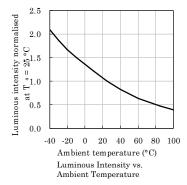


Green



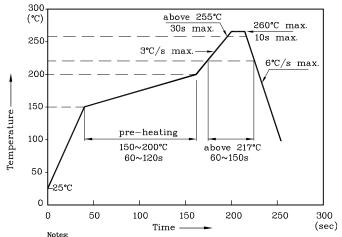






LED is recommended for reflow soldering and soldering profile is shown below.

Reflow Soldering Profile for SMD Products (Pb-Free Components)



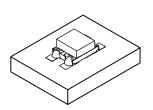
- 1. All temperatures refer to the center of the package,
- measured on the package body surface facing up during reflow.

 2. Do not apply any stress to the LED during high temperature conditions.
- 3. Maximum number of soldering passes: 2

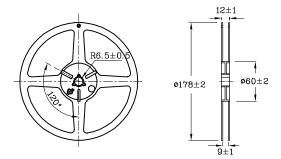




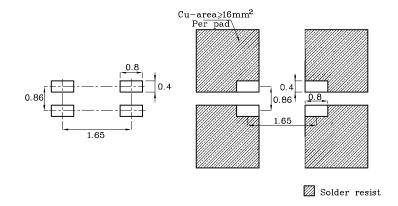
❖ The device has a single mounting surface. The device must be mounted according to the specifications.



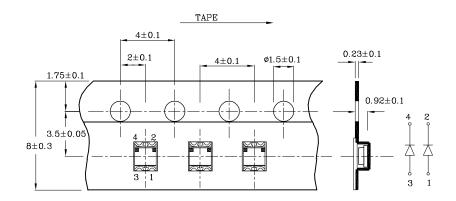
❖ Reel Dimension (Units:mm)



❖ Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



❖ Tape Specification (Units:mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

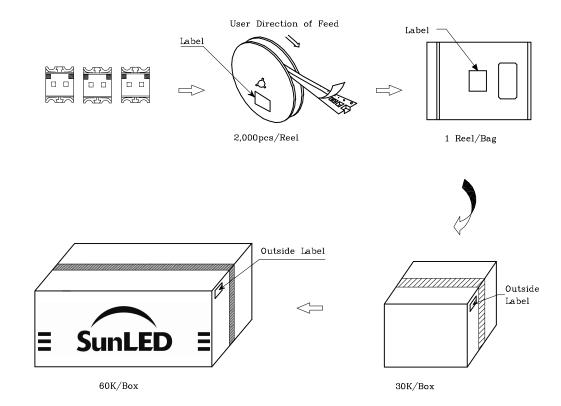
- 1. Wavelength: +/-1nm
- 2. Luminous intensity / luminous flux: +/-15%
- 3. Forward Voltage: +/-0.1V

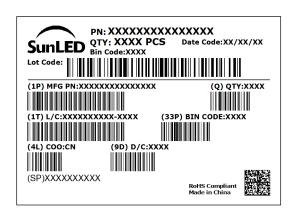
Note: Accuracy may depend on the sorting parameters.





PACKING & LABEL SPECIFICATIONS





TERMS OF USE

- 1. Data presented in this document reflect statistical figures and should be treated as technical reference only.
- $2. \ Contents \ within \ this \ document \ are \ subject \ to \ improvement \ and \ enhancement \ changes \ without \ notice.$
- 3. The product(s) in this document are designed to be operated within the electrical and environmental specifications indicated on the datasheet. User accepts full risk and responsibility when operating the product(s) beyond their intended specifications.
- 4. The product(s) described in this document are intended for electronic applications in which a person's life is not reliant upon the LED. Please consult with a SunLED representative for special applications where the LED may have a direct impact on a person's life.
- 5. The contents within this document may not be altered without prior consent by SunLED.
- 6. Additional technical notes are available at https://www.SunLEDusa.com/TechnicalNotes.asp

Dec 11,2020

 $1.6 \times 1.25 \text{ mm}$ High Temperature Series

Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below

Lot Tolerance Percent Defective (LTPD): 10%

No.	Test Item	Standards	Test Condition	Test Times / Cycles	Number of Damaged
1	Continuous operating test	-	T_a = 25°C, I_F = maximum rated current *	1,000 h	0 / 22
2	High Temp. operating test	EIAJ ED-4701/100(101)	T_a = 100°C, I_F = maximum rated current *	1,000 h	0 / 22
3	Low Temp. operating test	-	T_a = -40°C, I_F = maximum rated current *	1,000 h	0 / 22
4	High temp. storage test	EIAJ ED-4701/100(201)	T_a = maximum rated storage temperature	1,000 h	0 / 22
5	Low temp. storage test	EIAJ ED-4701/100(202)	$T_a = -40$ °C	1,000 h	0 / 22
6	High temp. & humidity storage test	EIAJ ED-4701/100(103)	$T_a = 60$ °C, RH = 90%	1,000 h	0 / 22
7	High temp. & humidity operating test	EIAJ ED-4701/100(102)	T_a = 60°C, RH = 90% I_F = maximum rated current *	1,000 h	0 / 22
8	Soldering reliability test	EIAJ ED-4701/100(301)	Moisture soak: 30°C, 70% RH, 72h Preheat: 150~180°C (120s max.) Soldering temp: 260°C(10s)	2 times	0 / 18
9	Thermal shock operating test	-	$\begin{split} T_a = -40 ^{\circ} C(15 min) \sim 100 ^{\circ} C(15 min) \\ I_F = derated \ current \ at \ 100 ^{\circ} C \end{split}$	1,000 cycles	0 / 22
10	Thermal shock test	-	T_a = -40°C(15min) ~ maximum rated Storage temperature(15min)	1,000 cycles	0 / 22
11	Electric Static Discharge (ESD)	EIAJ ED-4701/100(304)	$C = 100 pF$, $R2 = 1.5 K\Omega$ V = 3000 V (Red) V = 3000 V (Green)	Once each Polarity	0 / 22
12	Vibration test	-	$a = 196 \text{m/s}^2$, $f = 100 \sim 2 \text{KHz}$, $t = 48 \text{min for all xyz axes}$	4 times	0 / 22

 $[\]mbox{\ensuremath{\star}}$: Refer to forward current vs. derating curve diagram

Criteria for Judging Damage

Items	Symbols	Conditions	Failure Criteria
luminous Intensity	lv	$I_{\rm F} = 5 \text{mA}$	Testing Min. Value <spec.min.value 0.5<="" td="" x=""></spec.min.value>
Forward Voltage	VF	$I_{\rm F} = 5 \text{mA}$	Testing Max. Value ≥Spec.Max.Value x 1.2
Reverse Current	IR	VR = Maximum Rated Reverse Voltage	Testing Max. Value ≥Spec.Max.Value x 2.5
High temp. storage test	-	-	Occurrence of notable decoloration, deformation and cracking